

200mA High Speed LDO Regulator, Output Capacitor-Less, Low Power Consumption

■ GENERAL DESCRIPTION

The XC6501 series is a high speed, low noise CMOS LDO regulator that can provide stable output voltages even without a load capacitor C_L . This is possible because phase compensation is carried out internally unlike other LDOs where it is done externally. The series consists of a reference voltage source, driver transistor, error amplifier, current limit circuit, and phase compensation circuit.

The CE function enables the circuit to be put into stand-by mode by inputting a low level signal to the CE pin thereby reducing current consumption from an already low $13\mu\text{A}$ (in operation) to less than $0.1\mu\text{A}$. In the stand-by mode, if a C_L capacitor is used, the electric charge stored at C_L can be discharged via the internal auto-discharge switch and as a result, the V_{OUT} pin quickly returns to the V_{SS} level.

The current limit fold-back circuit operates as a short circuit protection and a current limiter function for the output pin.

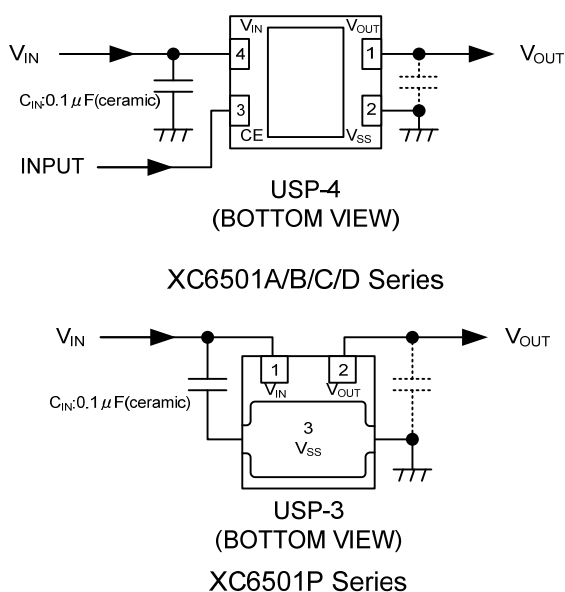
■ APPLICATIONS

- Mobile phones (RF, NFC, I/O etc.)
- Portable games
- Camera modules
- Wireless LAN modules
- LCD modules
- Bluetooth
- Digital-TV tuners

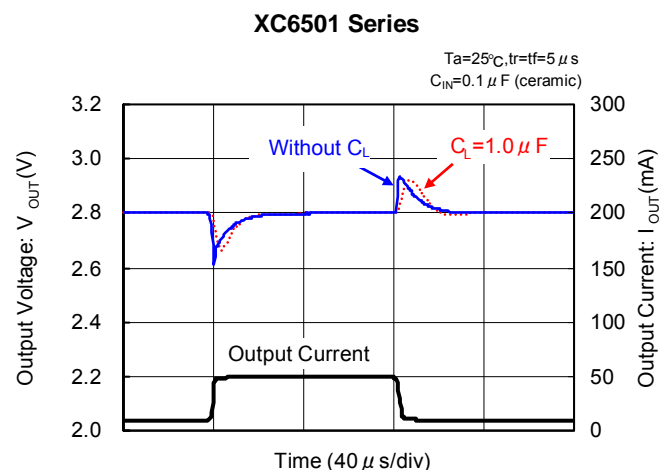
■ FEATURES

Maximum Output Current	: 200mA
Operating Voltage Range	: 1.4~6.0V
Output Voltage Range	: 1.2~5.0V
Output Voltage Accuracy	: $\pm 1\%$ or $\pm 0.02\text{V}$
Dropout Voltage	: $150\text{mV}@I_{\text{OUT}}=100\text{mA}, V_{\text{OUT}}=2.8\text{V}$
Low Power Supply	: $13\mu\text{A}@V_{\text{OUT}}=2.8\text{V}$
Stand-by Current	: Less than $0.1\mu\text{A}$
Ripple Rejection	: $50\text{dB}@f=1\text{kHz}, V_{\text{OUT}}=2.8\text{V}$
Protection Circuits	: Current limit (300mA, TYP.) Short circuit protection
Output capacitor is not required	: Internal phase compensation
C_L High Speed Auto Discharge	
Operating Ambient Temperature	: $-40^\circ\text{C}\sim+85^\circ\text{C}$
Packages	: SOT-25, SSOT-24, USP-4, USPN-4, USP-3
Environmentally Friendly	: EU RoHS Compliant, Pb Free

■ TYPICAL APPLICATION CIRCUIT

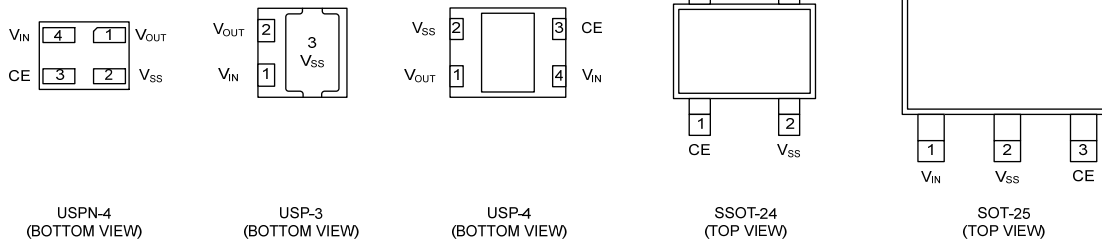


■ TYPICAL PERFORMANCE CHARACTERISTICS



XC6501 Series

PIN CONFIGURATION



*The heat dissipation pad of the USP-4 package is reference to solder as the reference mount pattern and metal mask pattern for mounting strength. The mount pattern should be electrically opened or connected to the V_{SS} (No.2) pin.

PIN ASSIGNMENT

PIN NUMBER					PIN NAME	FUNCTIONS
USP-3	USP-4	SSOT-24	SOT-25	USPN-4		
1	4	4	1	4	V_{IN}	Power Supply Input
2	1	3	5	1	V_{OUT}	Output
3	2	2	2	2	V_{SS}	Ground
-	3	1	3	3	CE	ON/OFF Control
-	-	-	4	-	NC	No Connection

FUNCTION CHART

1)XC6501 series A/B type

PIN NAME	SIGNAL	STATUS
CE	L	OFF
	H	ON
	OPEN	Undefined

2)XC6501 series C/D type

PIN NAME	SIGNAL	STATUS
CE	L	OFF
	H	ON
	OPEN	OFF

■PRODUCT CLASSIFICATION

●Ordering Information

XC6501①②③④⑤⑥-⑦^(*)

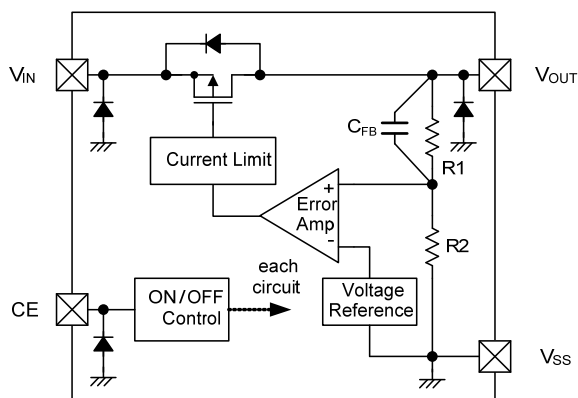
DESIGNATOR	ITEM	SYMBOL	DESCRIPTION
①	Regulator Type	A	CE High Active, Without CE Pull-down, Without C _L discharge
		B	CE High Active, Without CE Pull-down, With C _L discharge
		C	CE High Active, With CE Pull-down, Without C _L discharge
		D	CE High Active, With CE Pull-down, With C _L discharge
		P	3 pin, without CE pin (USP-3)
②③	Output Voltage	12~50	ex.)28V → ②=2, ③=8
④	Output Voltage Type [Accuracy]	1	0.1V increments ex.)1.80V → ②=1, ③=8, ④=1 [±0.02V @ 1.2V~1.9V, ±1% @ 2.0V~5.0V]
		A	0.05V increments ex.)1.85V → ②=1, ③=8, ④=A [±0.02V @ 1.25V~1.95V, ±1% @ 2.05V~4.95V]
⑤⑥-⑦ ^(*)	Packages (Order Unit)	HR	USP-3 ^(*) (3,000/Reel)
		HR-G	USP-3 ^(*) (3,000/Reel)
		GR	USP-4 (3,000/Reel)
		GR-G	USP-4 (3,000/Reel)
		NR	SSOT-24 (3,000/Reel)
		NR-G	SSOT-24 (3,000/Reel)
		MR	SOT-25 (3,000/Reel)
		MR-G	SOT-25 (3,000/Reel)
		7R-G	USPN-4 (5,000/Reel)

^(*) The “-G” suffix denotes Halogen and Antimony free as well as being fully RoHS compliant.

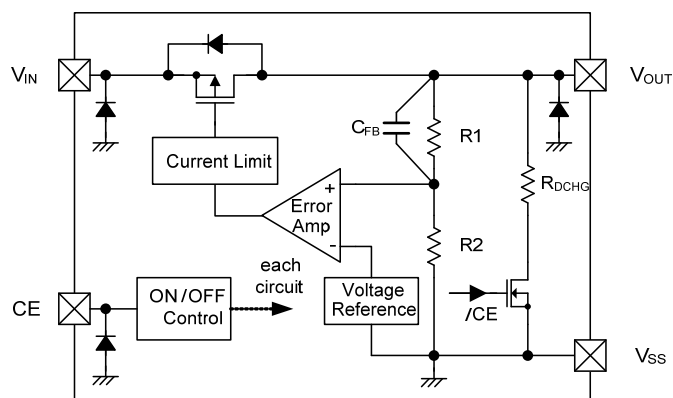
^(*) USP-3 is available only for XC6501P series.

BLOCK DIAGRAMS

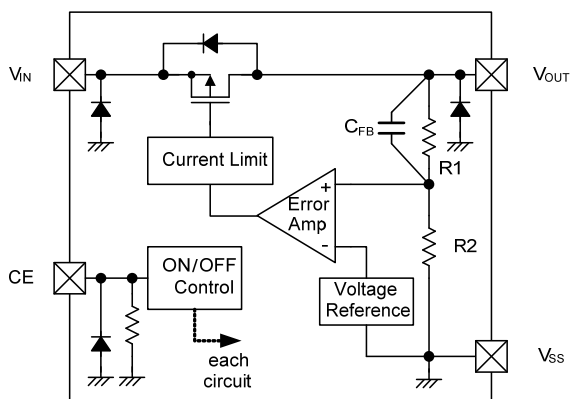
1) XC6501 Series A type



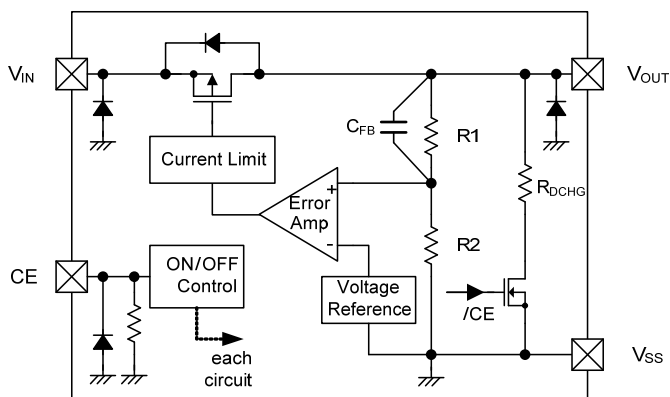
2) XC6501 Series B type



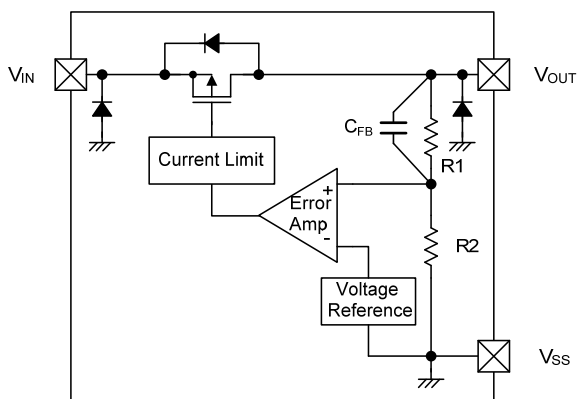
3) XC6501 Series C type



4) XC6501 Series D type



5) XC6501 Series P type



*Diodes inside the circuit are an ESD protection diode and a parasitic diode.

■ ABSOLUTE MAXIMUM RATINGS

PARAMETER		SYMBOL	RATINGS	UNITS
Input Voltage		V_{IN}	-0.3~+6.5	V
Output Current		I_{OUT}	400 ^(*)1)	mA
Output Voltage		V_{OUT}	-0.3~ $V_{IN}+0.3$ or +6.5 ^(*)2)	V
CE Input Voltage		V_{CE}	-0.3~+6.5	V
Power Dissipation	USPN-4	P_d	100	mW
			600 (PCB mounted) ^(*)3)	
	USP-3		120	
			1000 (PCB mounted) ^(*)3)	
	USP-4		120	
			1000 (PCB mounted) ^(*)3)	
	SSOT-24		150	
			500 (PCB mounted) ^(*)3)	
	SOT-25		250	
			600 (PCB mounted) ^(*)3)	
Operating Ambient Temperature		T_{opr}	-40~+85	°C
Storage Temperature		T_{stg}	-55~+125	°C

* All voltages are described based on the V_{SS} pin.

(*)1) $I_{OUT} \leq P_d / (V_{IN} - V_{OUT})$

(*)2) The maximum value should be $V_{IN}+0.3$ or +6.5 in the lowest.

(*)3) The power dissipation figure shown is PCB mounted and is for reference only. Please refer to page 24~28 for details.

ELECTRICAL CHARACTERISTICS

●XC6501 Series A/B/C/D Type

Ta=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS	CIRCUIT
Output Voltage	V _{OUT(E)} ^{(*)1}	V _{OUT(T)} ^{(*)2} ≤ 1.95V V _{CE} =V _{IN} , I _{OUT} =10mA	−0.02 ^{(*)3}	V _{OUT(T)}	+0.02 ^{(*)3}	V	①
		V _{OUT(T)} ≥ 2.0V V _{CE} =V _{IN} , I _{OUT} =10mA	×0.99 ^{(*)3}		×1.01 ^{(*)3}		
Maximum Output Current	I _{OUTMAX}	V _{CE} =V _{IN}	200	-	-	mA	①
Load Regulation	ΔV _{OUT}	V _{CE} =V _{IN} , 0.1mA ≤ I _{OUT} ≤ 100mA	-	15	45	mV	①
Dropout Voltage ^{(*)4}	V _{dif}	V _{CE} =V _{IN} , I _{OUT} =100mA	-	E-1 ^{(*)5}		mV	①
Supply Current	I _{SS}	V _{IN} =V _{CE} =6.0V, I _{OUT} =0mA	E-2 ^{(*)6}			μA	②
Stand-by Current	I _{STBY}	V _{IN} =6.0V, V _{CE} =V _{SS}	-	0.01	0.1	μA	②
Line Regulation	ΔV _{OUT} / (ΔV _{IN} •V _{OUT})	V _{OUT(T)} +0.5V ≤ V _{IN} ≤ 6.0V、 V _{CE} =V _{IN} , I _{OUT} =30mA	-	0.10	0.20	%/V	①
Input Voltage	V _{IN}		1.4	-	6.0	V	①
Output Voltage Temperature Characteristics	ΔV _{OUT} / (ΔT _{opr} •V _{OUT})	V _{CE} =V _{IN} , I _{OUT} =30mA -40℃ ≤ T _{opr} ≤ 85℃	-	±100	-	ppm/℃	①
Power Supply Rejection Ratio	PSRR	V _{OUT(T)} ≤ 4.75V V _{IN} ={V _{OUT(T)} +1.0} V _{DC} +0.5V _{p-pAC} V _{CE} =V _{IN} , I _{OUT} =30mA, f=1kHz	-	50	-	dB	③
		V _{OUT(T)} ≥ 4.80V V _{IN} =5.75V _{DC} +0.5V _{p-pAC} V _{CE} =V _{IN} , I _{OUT} =30mA, f=1kHz					
Current Limit	I _{LIM}	V _{CE} =V _{IN}	210	300	-	mA	①
Short - Circuit Current	I _{SHORT}	V _{CE} =V _{IN} , V _{OUT} is short-circuited at the V _{SS} level	-	25	-	mA	①
CE High Level Voltage	V _{CEH}		1.0	-	6.0	V	①
CE Low Level Voltage	V _{CEL}		V _{SS}	-	0.25	V	①
CE High Level Current	I _{CEH}	V _{CE} =V _{IN} =6.0V XC6501A/B XC6501C/D	-0.1	-	0.1	μA	①
			3.5	6.0	10		
CE Low Level Current	I _{CEL}	V _{CE} =V _{IN}	-0.1	-	0.1	μA	①
Auto-Discharge Resistance ^{(*)7}	R _{DCHG}	V _{IN} =6.0V, V _{OUT} =1.2V, V _{CE} =V _{SS}	-	250	300	Ω	①
		V _{IN} =6.0V, V _{OUT} =5.0V, V _{CE} =V _{SS}	-	400	480	Ω	

Notes:

Unless otherwise stated regarding input voltage conditions, $V_{IN}=V_{OUT(T)}^{(*)2}+1.0V$.

*1: $V_{OUT(E)}$: An actual output voltage when an amply stabilized($V_{OUT(T)}+1.0V$) is supplied with constant I_{OUT} .

*2: $V_{OUT(T)}$: Nominal output voltage value

*3: MIN and MAX values of $V_{OUT(E)}$ are shown in the voltage table "E-0".

*4: $V_{dif}=\{V_{IN1} - V_{OUT1}\}$

V_{IN1} : The input voltage when V_{OUT1} appears as input voltage is gradually decreased.

V_{OUT1} : A voltage equal to 98% of the output voltage when an amply stabilized I_{OUT} ($V_{OUT(T)}+1.0V$) is input.

*5: Please refer to page E-1.

*6: Please refer to page E-2.

*7: This function is built in the XC6501B/D series only.

The XC6501A/C series discharges by only R1+ R2 resistors as shown in the block diagrams.

■ ELECTRICAL CHARACTERISTICS (Continued)

● XC6501 Series P Type

Ta=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS	CIRCUIT
Output Voltage	$V_{OUT(E)}^{(*)1}$	$V_{OUT(T)}^{(*)2} \leq 1.95V$ $I_{OUT}=10mA$	-0.02 ^{(*)3}	$V_{OUT(T)}$	+0.02 ^{(*)3}	V	①
		$V_{OUT(T)} \geq 2.0V$ $I_{OUT}=10mA$	$\times 0.99^{(*)3}$		$\times 1.01^{(*)3}$		
Maximum Output Current	I_{OUTMAX}		200	-	-	mA	①
Output Voltage	ΔV_{OUT}	$0.1mA \leq I_{OUT} \leq 100mA$	-	15	45	mV	①
Dropout Voltage ^{(*)4}	V_{dif}	$I_{OUT}=100mA$	-	$E-1^{(*)5}$		mV	①
Supply Current	I_{SS}	$V_{IN}=6.0V$ 、 $I_{OUT}=0mA$	$E-2^{(*)6}$			μA	②
Line Regulation	$\Delta V_{OUT}/$ $(\Delta V_{IN} \cdot V_{OUT})$	$V_{OUT(T)}+0.5V \leq V_{IN} \leq 6.0V$ 、 $I_{OUT}=30mA$	-	0.10	0.20	%/V	①
Input Voltage	V_{IN}		1.4	-	6.0	V	①
Output Voltage Temperature Characteristics	$\Delta V_{OUT}/$ $(\Delta T_{opr} \cdot V_{OUT})$	$I_{OUT}=30mA$ $-40^{\circ}C \leq T_{opr} \leq 85^{\circ}C$	-	± 100	-	ppm	①
Power Supply Rejection Ratio	PSRR	$V_{OUT(T)} \leq 4.75V$ $V_{IN} = \{V_{OUT(T)} + 1.0\} V_{DC} + 0.5V_{p-pAC}$ $I_{OUT}=30mA$ 、 $f=1kHz$	-	50	-	dB	③
		$V_{OUT(T)} \geq 4.80V$ $V_{IN}=5.75V_{DC}+0.5V_{p-pAC}$ $I_{OUT}=30mA$ 、 $f=1kHz$					
Current Limit	I_{LIM}		210	300	-	mA	①
Short Circuit Current	I_{SHORT}	V_{OUT} is short-circuited at the V_{SS} level	-	25	-	mA	①

Notes:

Unless otherwise stated regarding input voltage conditions, $V_{IN}=V_{OUT(T)}^{(*)2}+1.0V$.

*1: $V_{OUT(E)}$: An actual output voltage when an amply stabilized ($V_{OUT(T)}+1.0V$) is supplied with constant I_{OUT} .

*2: $V_{OUT(T)}$: Nominal output voltage value

*3: MIN and MAX values of $V_{OUT(E)}$ are shown in the voltage table "E-0".

*4: $V_{dif}=\{V_{IN1} - V_{OUT1}\}$

V_{IN1} : The input voltage when V_{OUT1} appears as input voltage is gradually decreased.

V_{OUT1} : A voltage equal to 98% of the output voltage when an amply stabilized I_{OUT} ($V_{OUT(T)}+1.0V$) is input.

*5: Please refer to page E-1.

*6: Please refer to page E-2.

■ ELECTRICAL CHARACTERISTICS (Continued)

● Voltage Chart

	E-0		E-1		E-2								
NOMINAL VOLTAGE (V)	OUTPUT VOLTAGE (V)		DROPOUT VOLTAGE (mV)		SUPPLY CURRENT (μ A)								
V _{OUT(T)}	V _{OUT(E)}		V _{dif}		I _{SS}								
	MIN.	MAX.	TYP.	MAX.	MIN.	TYP.	MAX.						
1.20	1.1800	1.2200	440	690	5	11	17						
1.25	1.2300	1.2700											
1.30	1.2800	1.3200											
1.35	1.3300	1.3700											
1.40	1.3800	1.4200	300	610				5	11	17			
1.45	1.4300	1.4700											
1.50	1.4800	1.5200											
1.55	1.5300	1.5700											
1.60	1.5800	1.6200	260	530							5	11	17
1.65	1.6300	1.6700											
1.70	1.6800	1.7200											
1.75	1.7300	1.7700											
1.80	1.7800	1.8200	230	470	5	11	17						
1.85	1.8300	1.8700											
1.90	1.8800	1.9200											
1.95	1.9300	1.9700											
2.00	1.9800	2.0200	200	430				6	12	18			
2.05	2.0295	2.0705											
2.10	2.0790	2.1210											
2.15	2.1285	2.1715											
2.20	2.1780	2.2220	190	410							6	12	19
2.25	2.2275	2.2725											
2.30	2.2770	2.3230											
2.35	2.3265	2.3735											
2.40	2.3760	2.4240	210	380	6	12	19						
2.45	2.4255	2.4745											
2.50	2.4750	2.5250											
2.55	2.5245	2.5755											
2.60	2.5740	2.6260	210	380				6	12	19			
2.65	2.6235	2.6765											
2.70	2.6730	2.7270											
2.75	2.7225	2.7775											
2.80	2.7720	2.8280	150	360							6	12	20
2.85	2.8215	2.8785											
2.90	2.8710	2.9290											
2.95	2.9205	2.9795											
3.00	2.9700	3.0300	150	360	7	14	20						
3.05	3.0195	3.0805											

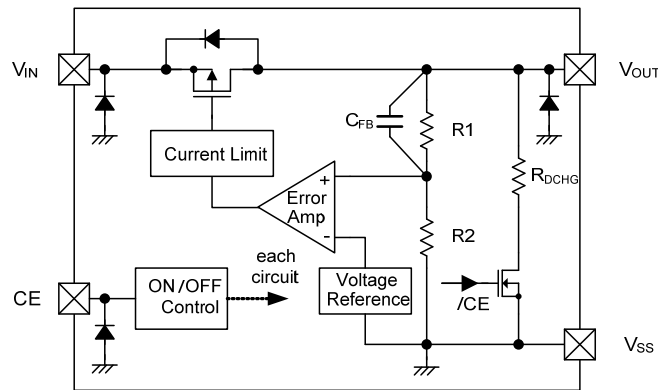
■ ELECTRICAL CHARACTERISTICS (Continued)

● Voltage Table (continued)

	E-0		E-1		E-2		
NOMINAL VOLTAGE (V)	OUTPUT VOLTAGE (V)		DROPOUT VOLTAGE (mV)		SUPPLY CURRENT (μ A)		
V _{OUT(T)}	V _{OUT(E)}		V _{dif}		I _{SS}		
	MIN.	MAX.	TYP.	MAX.	MIN.	TYP.	MAX.
3.10	3.0690	3.1310	150	360	7	14	21
3.15	3.1190	3.1820					
3.20	3.1680	3.2320	140	350			
3.25	3.2175	3.2825					
3.30	3.2670	3.3330					
3.35	3.3165	3.3835					
3.40	3.3660	3.4340					
3.45	3.4155	3.4845					
3.50	3.4650	3.5350					
3.55	3.5145	3.5855					
3.60	3.5640	3.6360	130	340		15	22
3.65	3.6135	3.6865					
3.70	3.6630	3.7370					
3.75	3.7125	3.7875					
3.80	3.7620	3.8380					
3.85	3.8115	3.8885					
3.90	3.8610	3.9390					
3.95	3.9105	3.9895					
4.00	3.9600	4.0400					
4.05	4.0095	4.0905					
4.10	4.0590	4.1410	120	330	8	16	23
4.15	4.1085	4.1915					
4.20	4.1580	4.2420					
4.25	4.2075	4.2925					
4.30	4.2570	4.3430					
4.35	4.3065	4.3935					
4.40	4.3560	4.4440					
4.45	4.4055	4.4945					
4.50	4.4550	4.5450					
4.55	4.5045	4.5955					
4.60	4.5540	4.6460					
4.65	4.6035	4.6965					
4.70	4.6530	4.7470					
4.75	4.7025	4.7975					
4.80	4.7520	4.8480					
4.85	4.8015	4.8985					
4.90	4.8510	4.9490					
4.95	4.9005	4.9995					
5.00	4.9500	5.0500					

■ OPERATIONAL EXPLANATION

The voltage divided by resistors R1 & R2 is compared with the internal reference voltage by the error amplifier. The P-channel MOSFET which is connected to the V_{OUT} pin is then driven by the subsequent output signal. The output voltage at the V_{OUT} pin is controlled & stabilized by a system of negative feedback. The current limit circuit and short protect circuit operate in relation to the level of output current. Further, the IC's internal circuitry can be shutdown via the CE pin's signal.



XC6501 Series B Type

<C_L High Speed Auto-Discharge Function>

The XC6501B/D series can discharge the electric charge in the output capacitor C_L, when a low signal to the CE pin, which enables a whole IC circuit turn off, is inputted via the N-channel transistor located between the V_{OUT} pin and the V_{SS} pin as shown in the BLOCK DIAGRAM. The C_L auto-discharge resistance value is set at 400Ω (V_{OUT}=5.0V @ V_{IN}=6.0V at typical). The discharge time of the output capacitor C_L is set by the C_L auto-discharge resistance R and the output capacitor C_L. By setting time constant of a C_L auto-discharge resistance value R_{DCHG} and an output capacitor value C_L as τ (τ=C x R_{DCHG}), the output voltage after discharge via the N-channel transistor is calculated by the following formulas.

$$V = V_{OUT(E)} \times e^{-t/\tau}$$

or an expanded formula is

$$t = \tau \times \ln(V_{OUT(E)}/V)$$

V : Output voltage after discharge

V_{OUT(E)} : Output voltage

t : Discharge time

τ : R_{DCHG} × C_L

R_{DCHG} : C_L auto-discharge resistance

C_L : Output capacitor

<Current Limiter, Short-Circuit Protection>

The XC6501 series' fold-back circuit operates as an output current limiter and a short protection of the output pin. When the load current reaches the current limit level, the fixed current limiter circuit operates and output voltage drops. When the output voltage is shorted to the V_{SS}, its current flow reached and minimized to about 25mA.

<CE Pin>

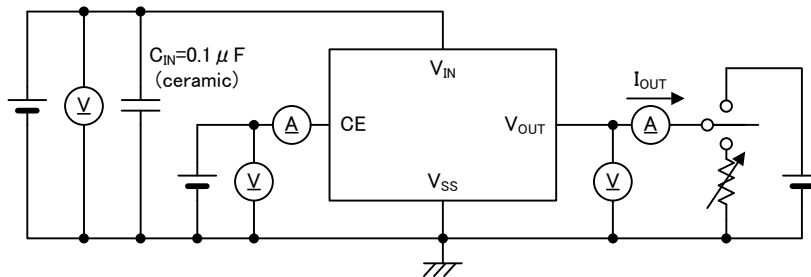
The IC's internal circuitry can be shutdown via the signal from the CE pin with the XC6501 series. In shutdown mode output at the V_{OUT} pin will be pulled down to the V_{SS} level via R1 & R2. However, as for the XC6501B/D series, the C_L auto-discharge resistor is connected in parallel to R1 and R2 while the power supply is applied to the V_{IN} pin. Therefore, time until the V_{OUT} pin reaches the V_{SS} level becomes short. The output voltage becomes unstable, when the CE pin is open. If this IC is used with the correct output voltage for the CE pin, the logic is fixed and the IC will operate normally. However, supply current may increase as a result of through current in the IC's internal circuitry when medium voltage is input.

■NOTES ON USE

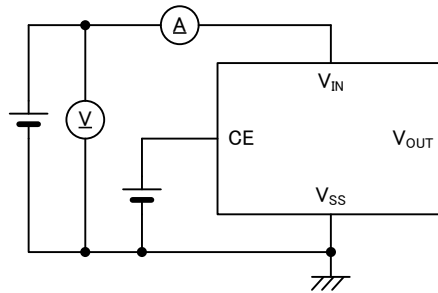
1. Please use this IC within the stated absolute maximum ratings. The IC is liable to malfunction should the ratings be exceeded.
2. This IC achieves stable operation without an output capacitor C_L by internal phase compensation. However, wiring impedance is high, operations may become unstable due to noise and/or phase lag depending on output current. Please wire the input capacitor C_{IN} and the output capacitor C_L as close to the IC as possible.
3. Torex places an importance on improving our products and their reliability.
We request that users incorporate fail-safe designs and post-aging protection treatment when using Torex products in their systems.

TEST CIRCUITS

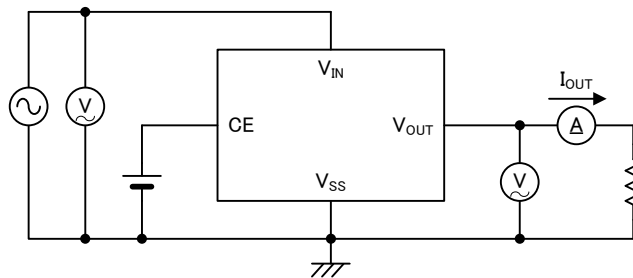
● Circuit ①



● Circuit ②



● Circuit ③

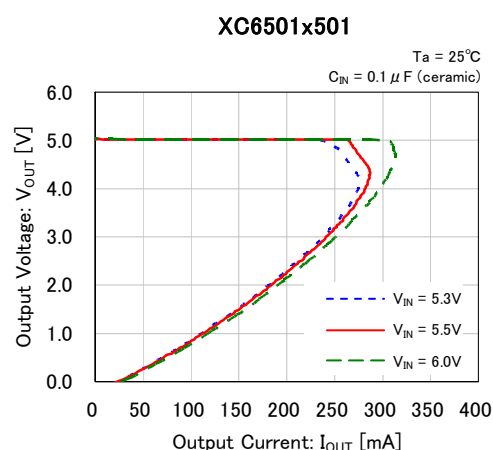
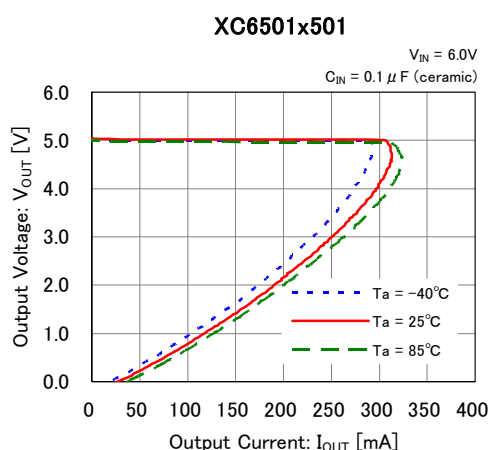
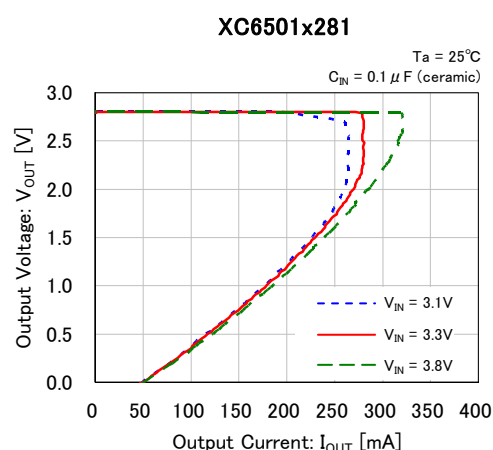
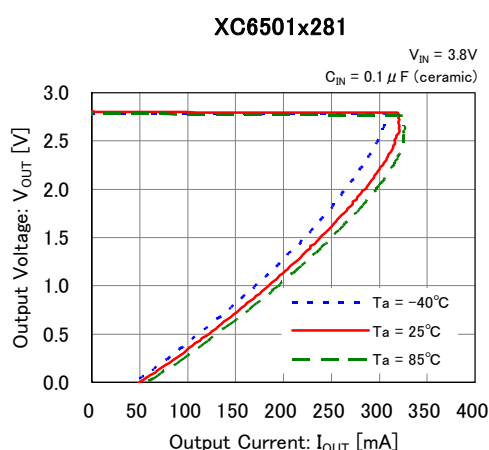
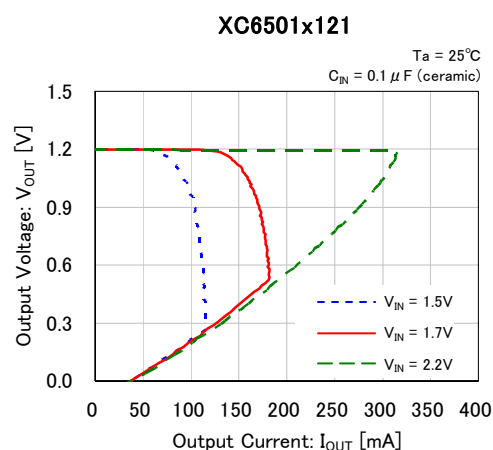
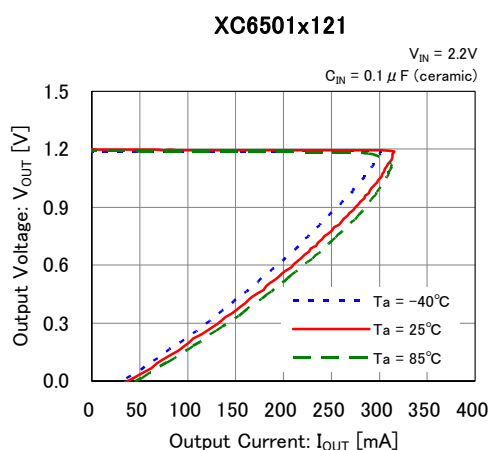


The CE pin does not exist in the XC6501 series P type, please disregard CE description in above test circuit.

■ TYPICAL PERFORMANCE CHARACTERISTICS

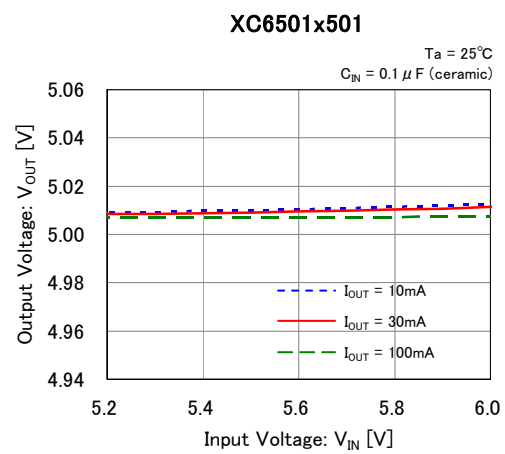
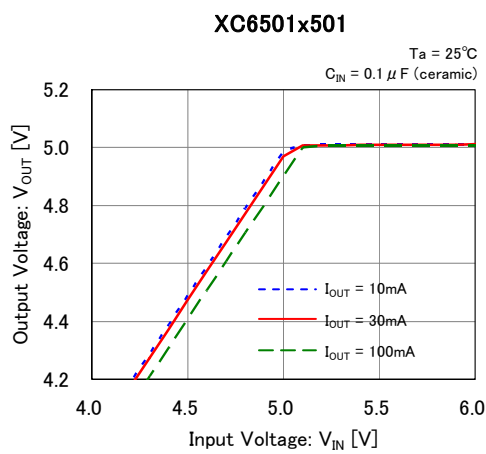
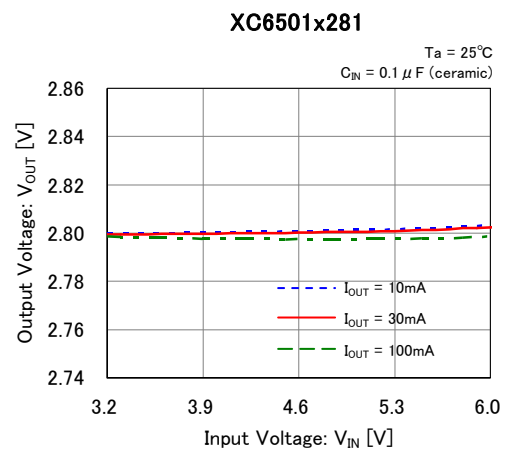
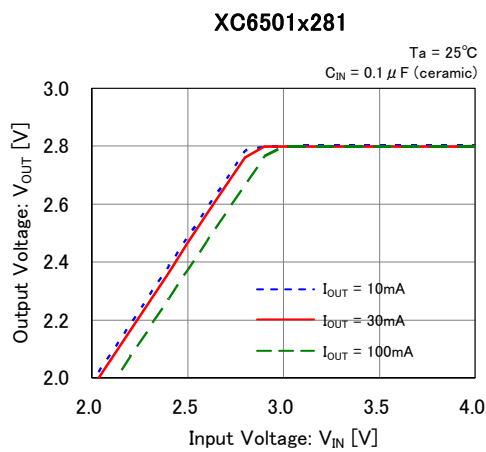
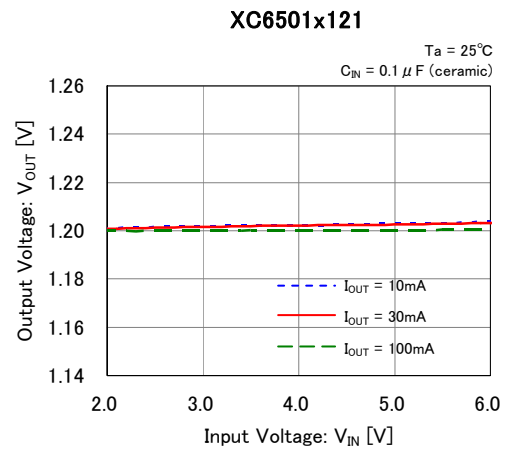
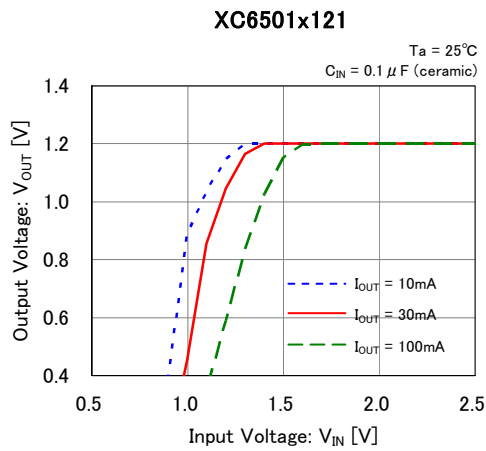
*CE Voltage condition: Unless otherwise stated, $V_{CE} = V_{IN}$

(1) Output Voltage vs. Output Current



TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

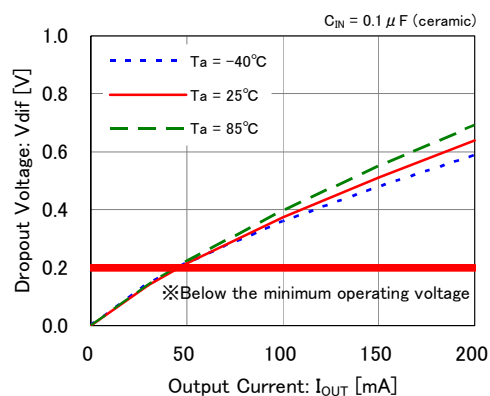
(2) Output Voltage vs. Input Voltage



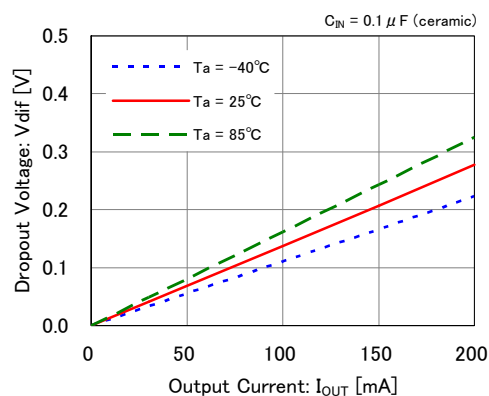
■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(3) Dropout Voltage vs. Output Current

XC6501x121

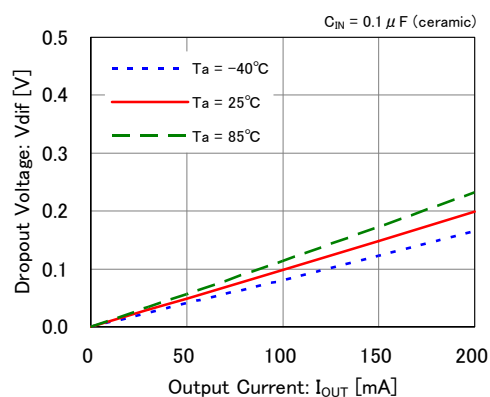


XC6501x281

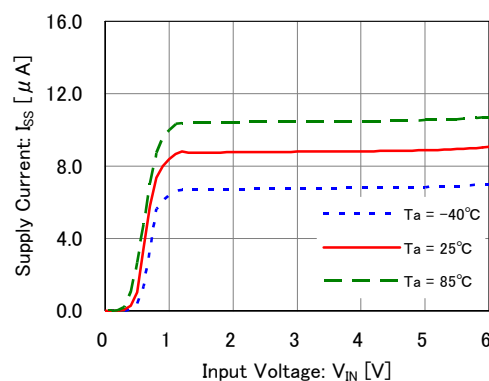


(4) Supply Current vs. Input Voltage

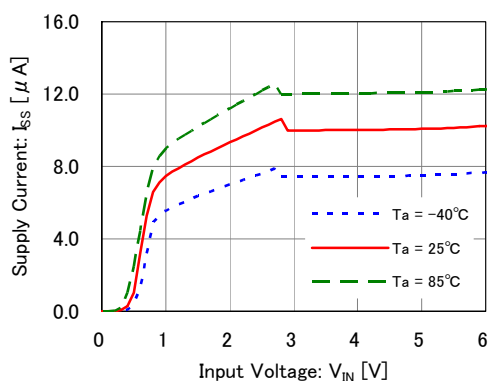
XC6501x501



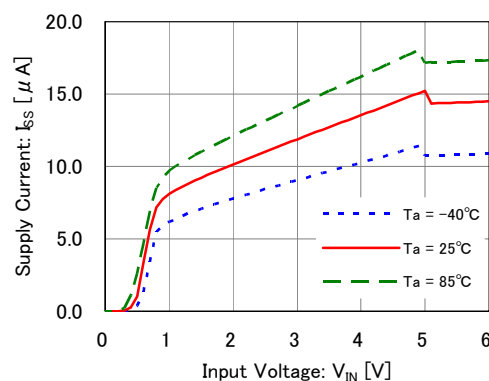
XC6501x121



XC6501x281

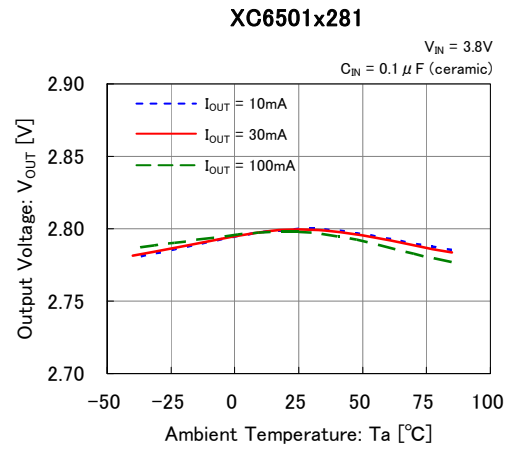
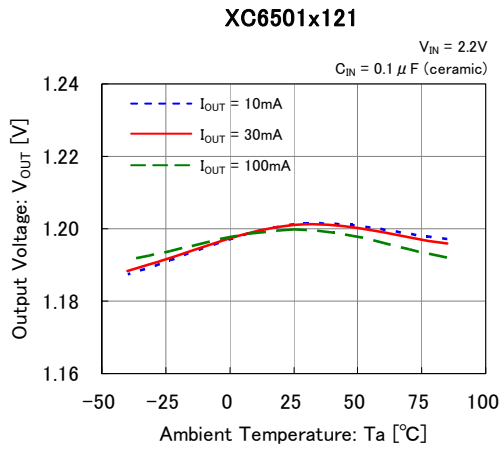


XC6501x501

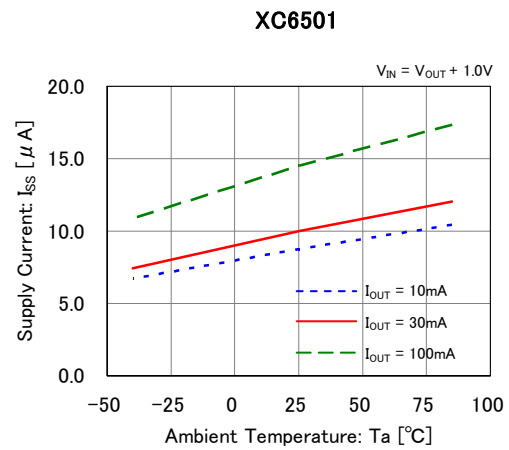
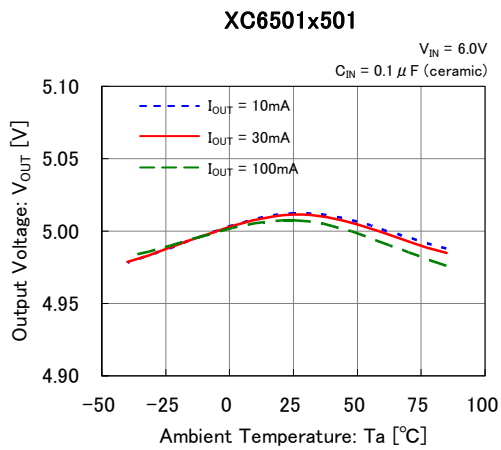


TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

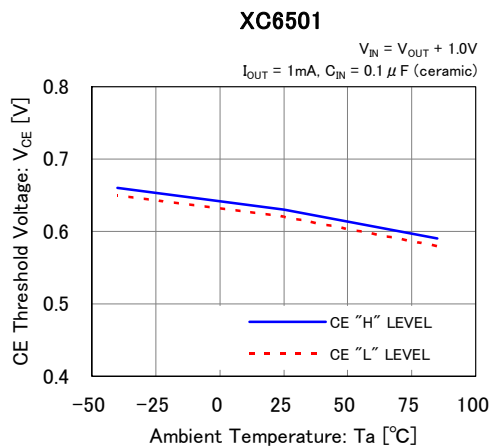
(5) Output Voltage vs. Ambient Temperature



(6) Supply Current vs. Ambient Temperature

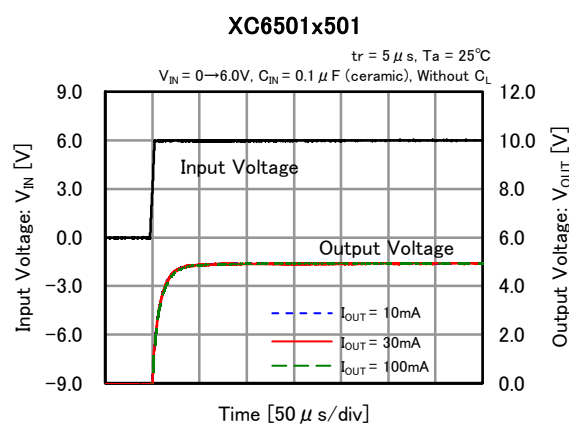
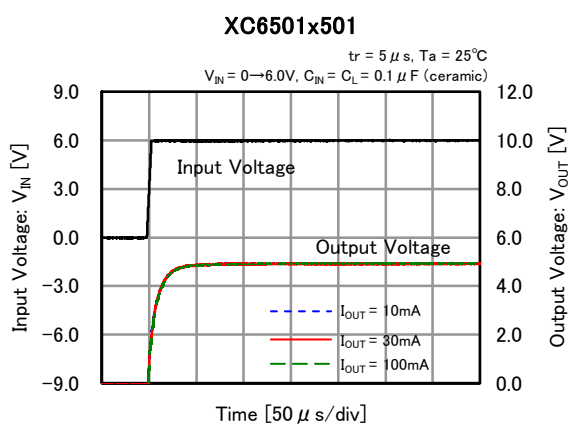
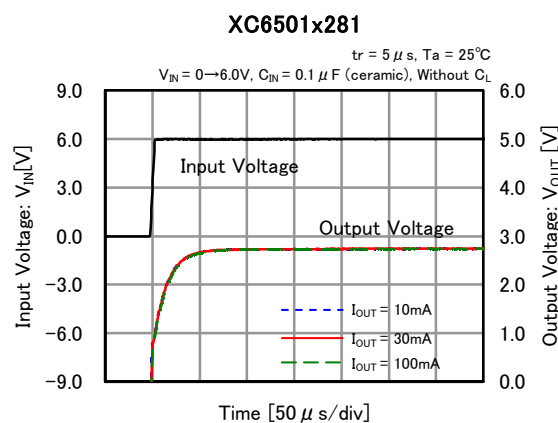
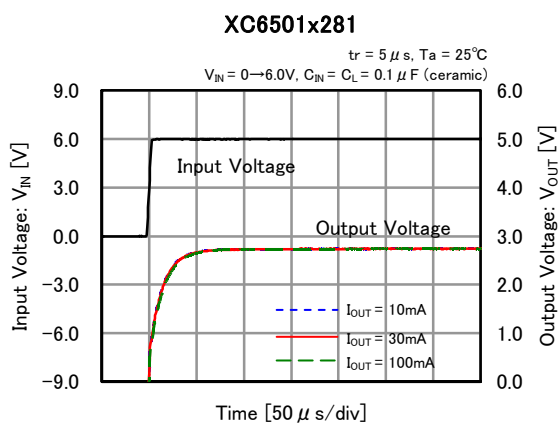
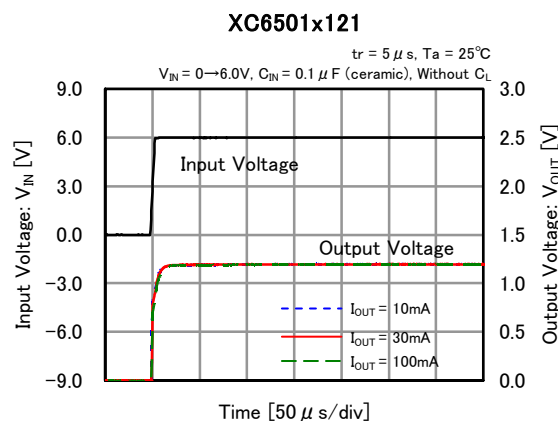
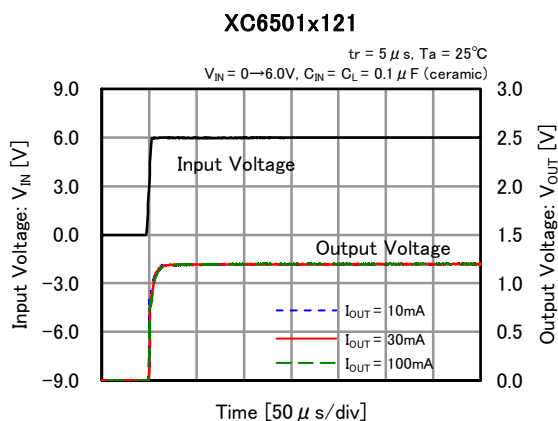


(7) CE Threshold Voltage vs. Ambient Temperature



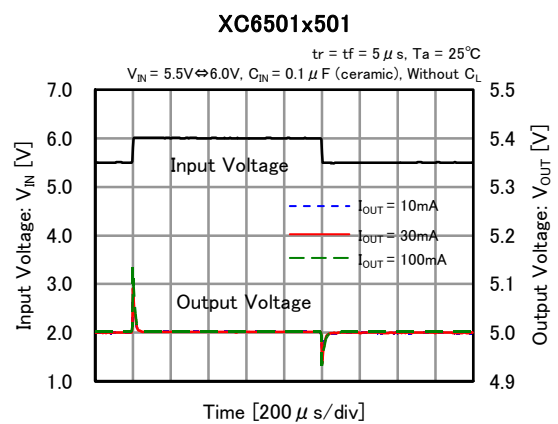
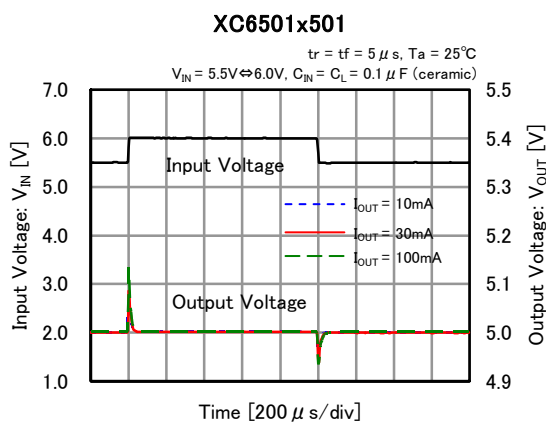
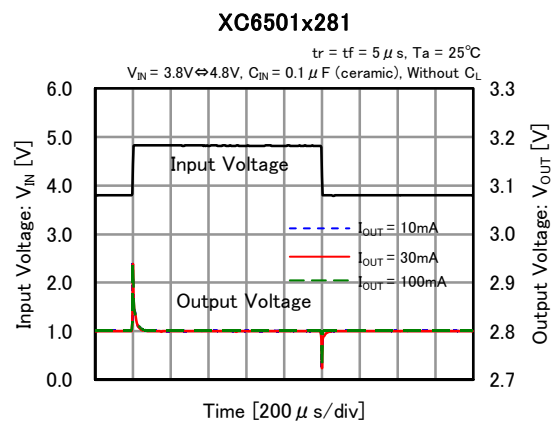
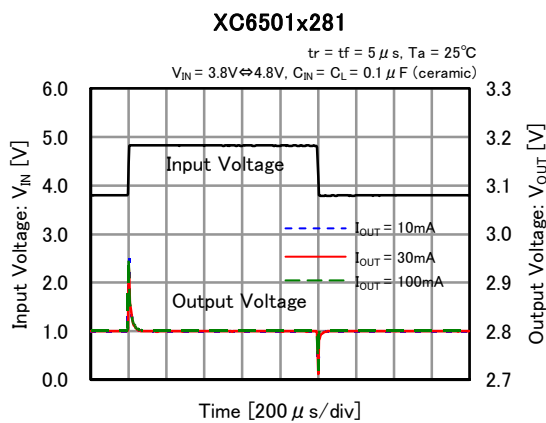
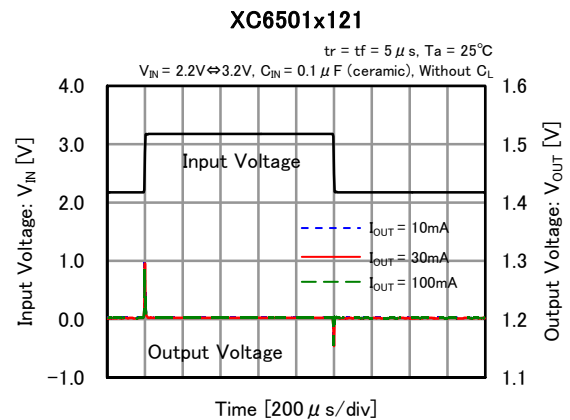
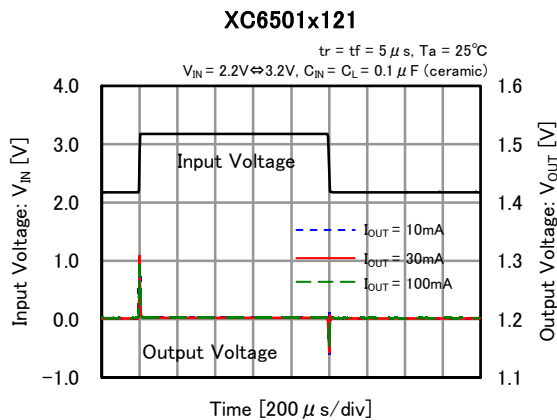
■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(8) Rising Response Time



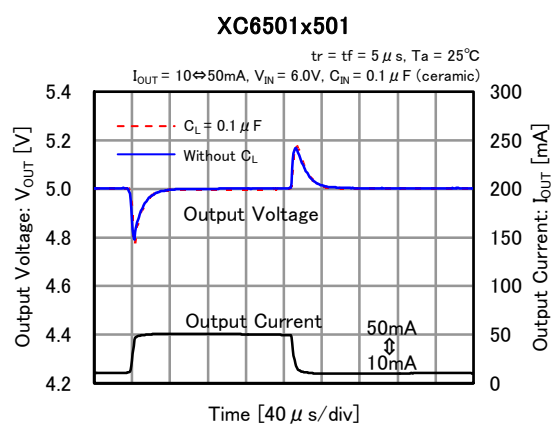
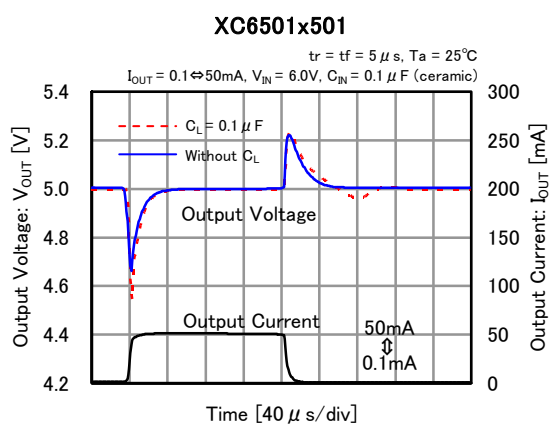
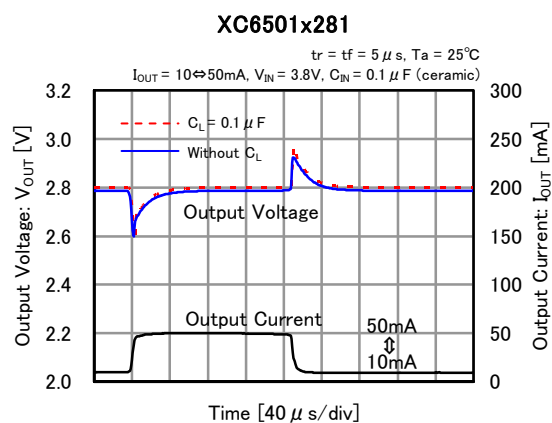
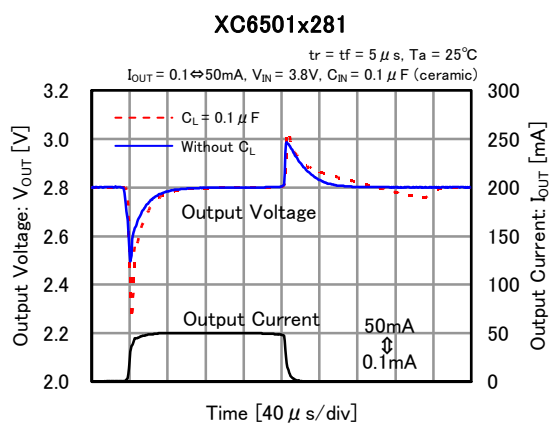
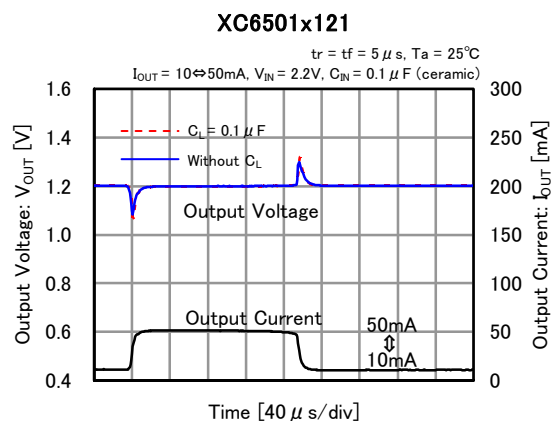
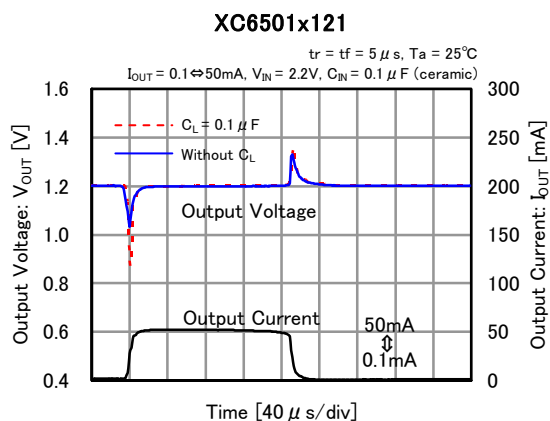
TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(9) Input Transient Response



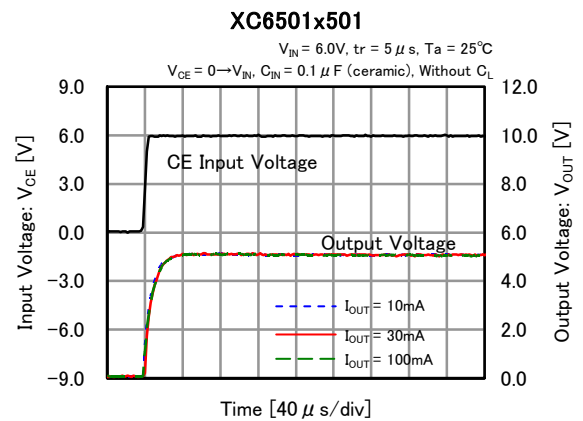
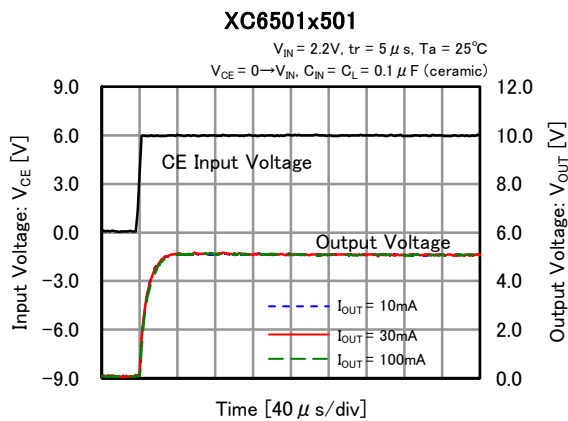
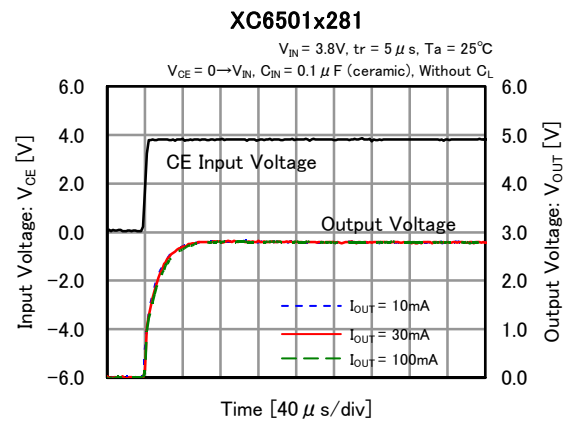
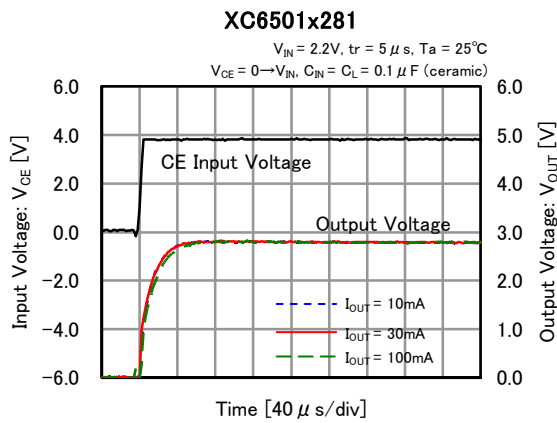
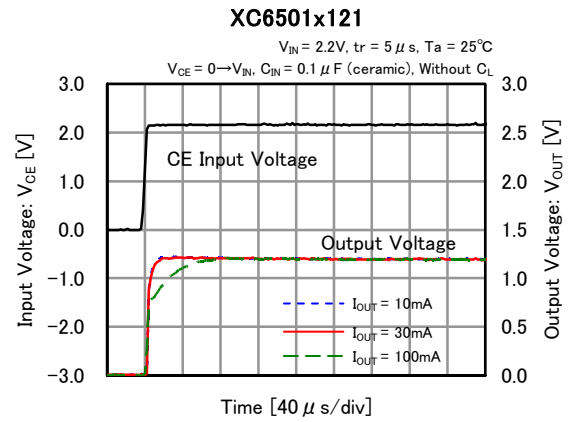
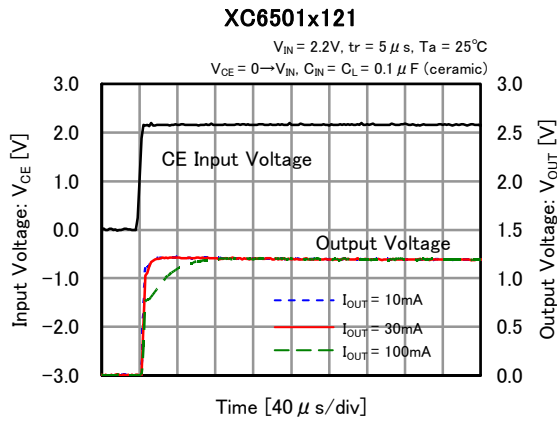
■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(10) Load Transient Response



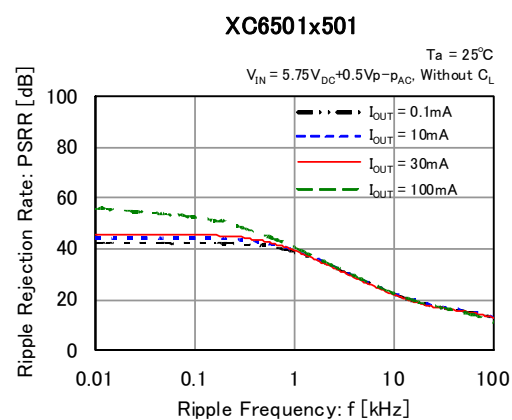
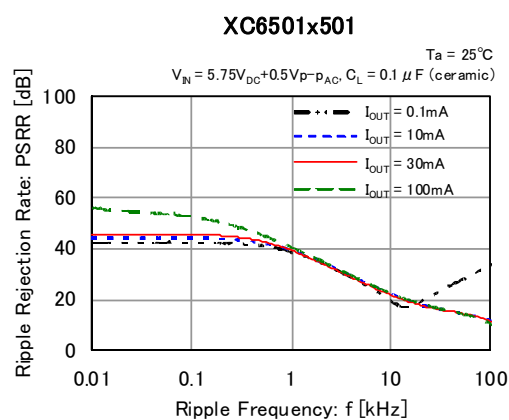
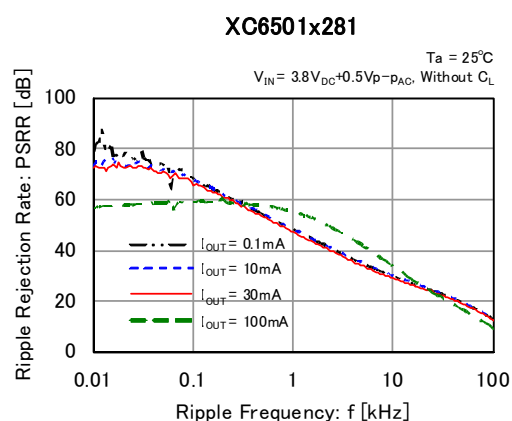
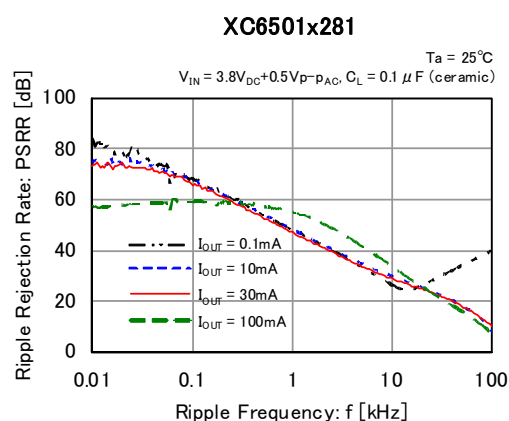
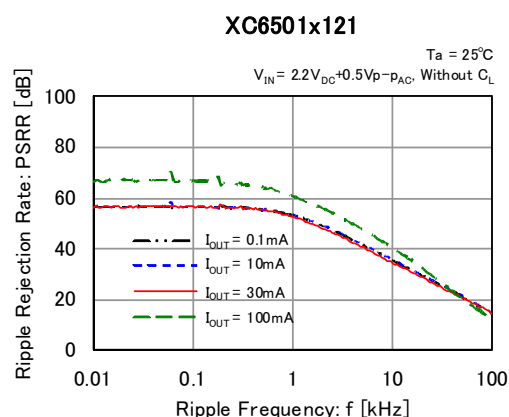
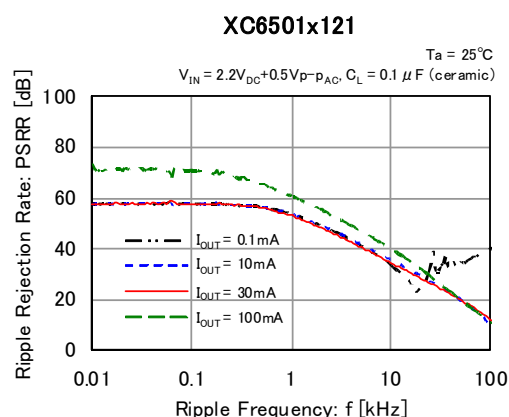
TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(11) CE Rising Respose Time



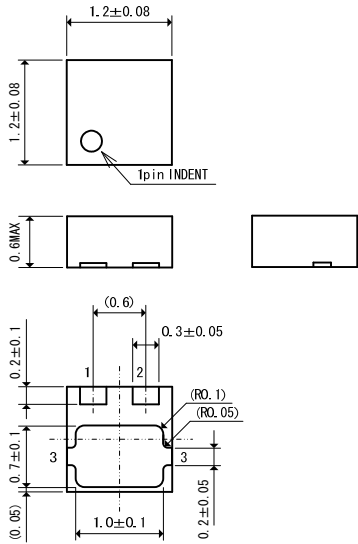
■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(12) Ripple Rejection Rate

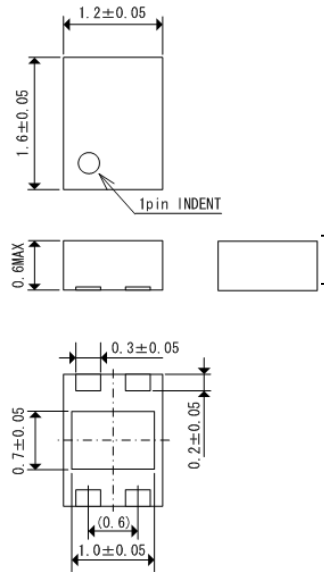


■ PACKAGING INFORMATION

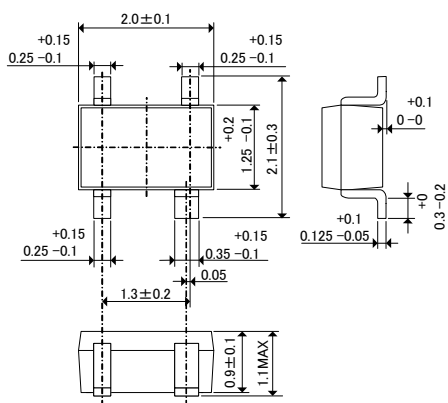
- USP-3



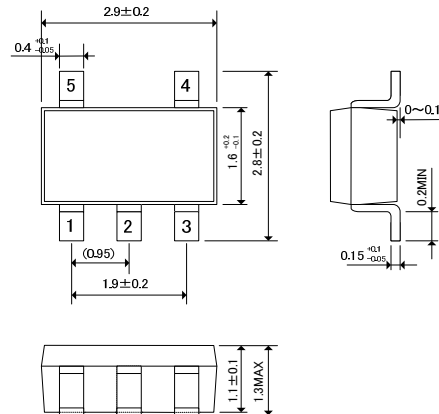
- USP-4



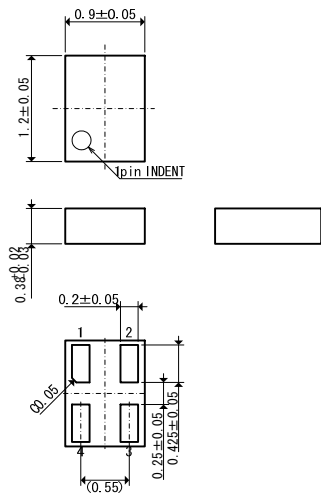
● SSOT-24



● SOT-25

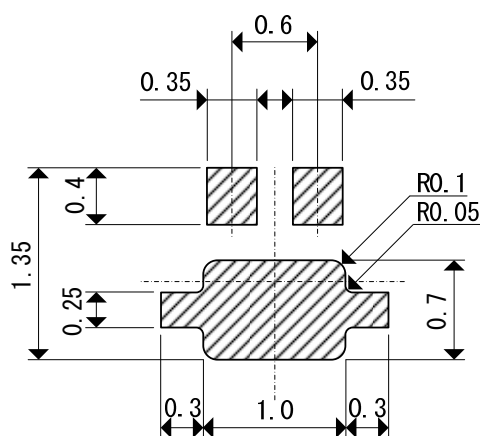


● USPN-4

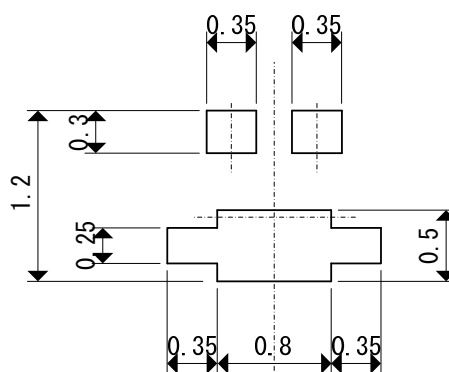


■ PACKAGING INFORMATION (Continued)

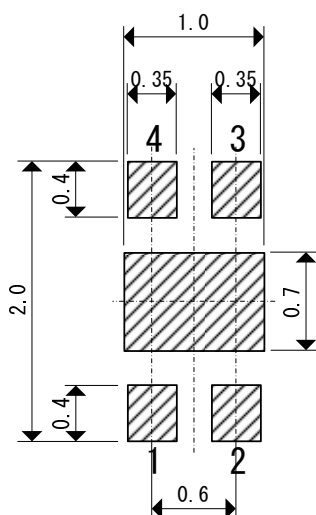
● USP-3 Reference Pattern Layout



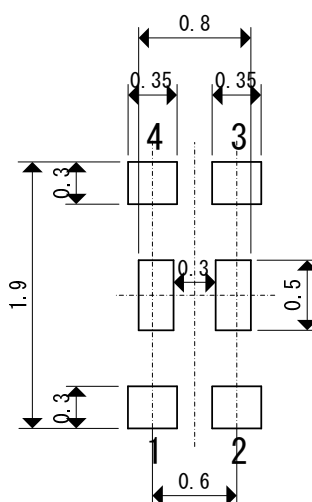
● USP-3 Reference Metal Mask Design



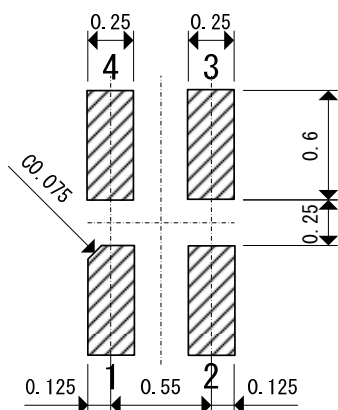
● USP-4 Reference Pattern Layout



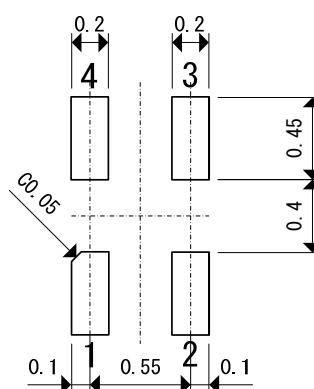
● USP-4 Reference Metal Mask Design



● USPN-4 Reference Pattern Layout



● USPN-4 Reference Metal Mask Design



XC6501 Series

● USPN-4 Power Dissipation

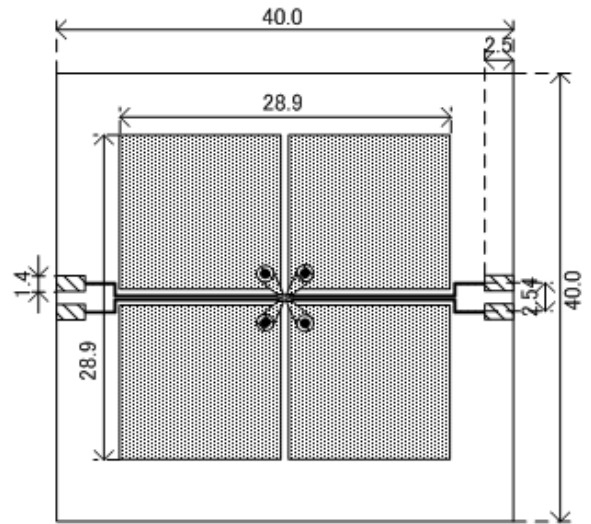
Power dissipation data for the USPN-4 is shown in this page.

The value of power dissipation varies with the mount board conditions.

Please use this data as one of reference data taken in the described condition.

1. Measurement Condition (Reference data)

Condition: Mount on a board
Ambient: Natural convection
Soldering: Lead (Pb) free
Board: Dimensions 40 x 40 mm (1600 mm² in one side)
Copper (Cu) traces occupy 50% of the front and 50% of the back.
The copper area is divided into four block, one block is 12.5% of total.
The USPN-4 package has for terminals.
Each terminal connects one copper block in the front and one in the back.
Material: Glass Epoxy (FR-4)
Thickness: 1.6 mm
Through-hole: 4 x 0.8 Diameter

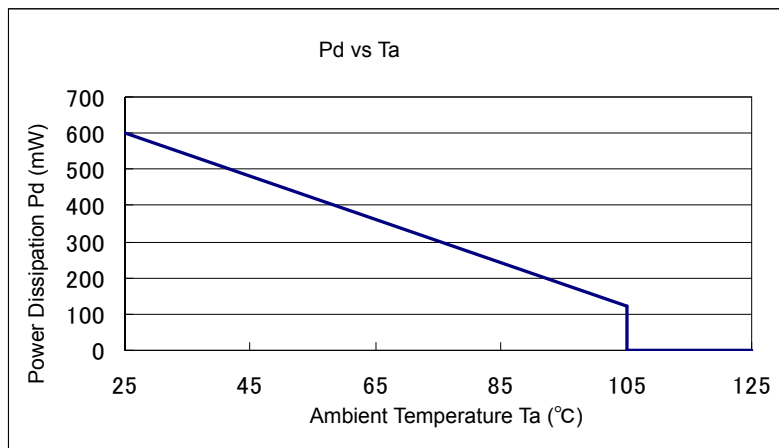


Evaluation Board (Unit: mm)

2. Power Dissipation vs. Ambient Temperature

Board Mount ($T_j \text{ max} = 125^\circ\text{C}$)

Ambient Temperature ($^\circ\text{C}$)	Power Dissipation P_d (mW)	Thermal Resistance ($^\circ\text{C}/\text{W}$)
25	600	166.67
105	120	

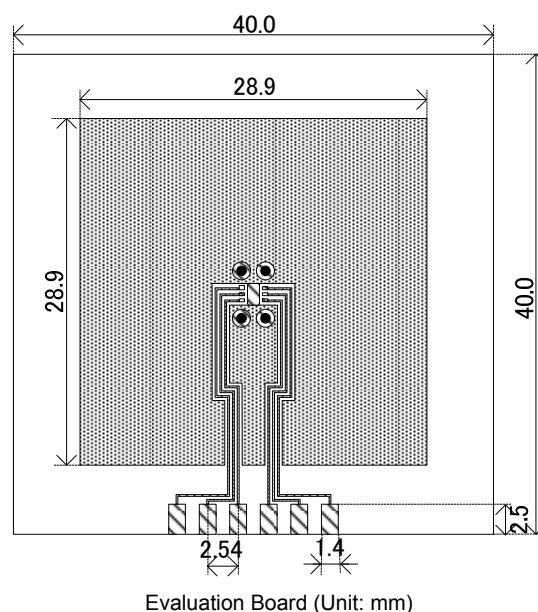


● USP-4 Power Dissipation

Power dissipation data for the USP-4 is shown in this page.
The value of power dissipation varies with the mount board conditions.
Please use this data as one of reference data taken in the described condition.

1. Measurement Condition (Reference data)

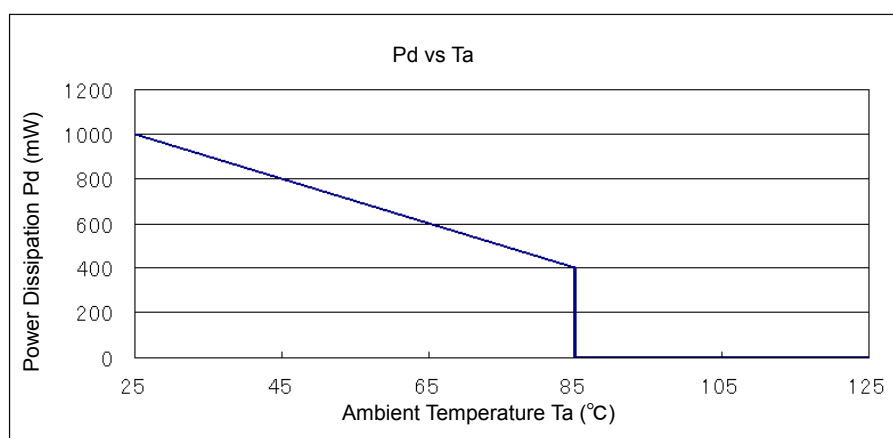
Condition: Mount on a board
Ambient: Natural convection
Soldering: Lead (Pb) free
Board: Dimensions 40 x 40 mm (1600 mm² in one side)
Copper (Cu) traces occupy 50% of the board area
In top and back faces
Package heat-sink is tied to the copper traces
Material: Glass Epoxy (FR-4)
Thickness: 1.6 mm
Through-hole: 4 x 0.8 Diameter



2. Power Dissipation vs. Ambient Temperature

Board Mount ($T_j \text{ max} = 125^\circ\text{C}$)

Ambient Temperature ($^\circ\text{C}$)	Power Dissipation Pd (mW)	Thermal Resistance ($^\circ\text{C/W}$)
25	1000	100.00
85	400	

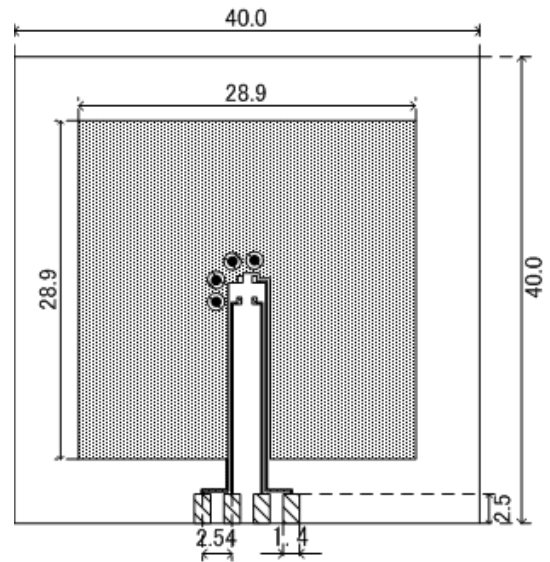


● SSOT-24 Power Dissipation

Power dissipation data for the SSOT-24 is shown in this page.
The value of power dissipation varies with the mount board conditions.
Please use this data as one of reference data taken in the described condition.

1. Measurement Condition (Reference data)

Condition: Mount on a board
Ambient: Natural convection
Soldering: Lead (Pb) free
Board: Dimensions 40 x 40 mm (1600 mm² in one side)
Copper (Cu) traces occupy 50% of the board area
In top and back faces
Package heat-sink is tied to the copper traces
Material: Glass Epoxy (FR-4)
Thickness: 1.6 mm
Through-hole: 4 x 0.8 Diameter

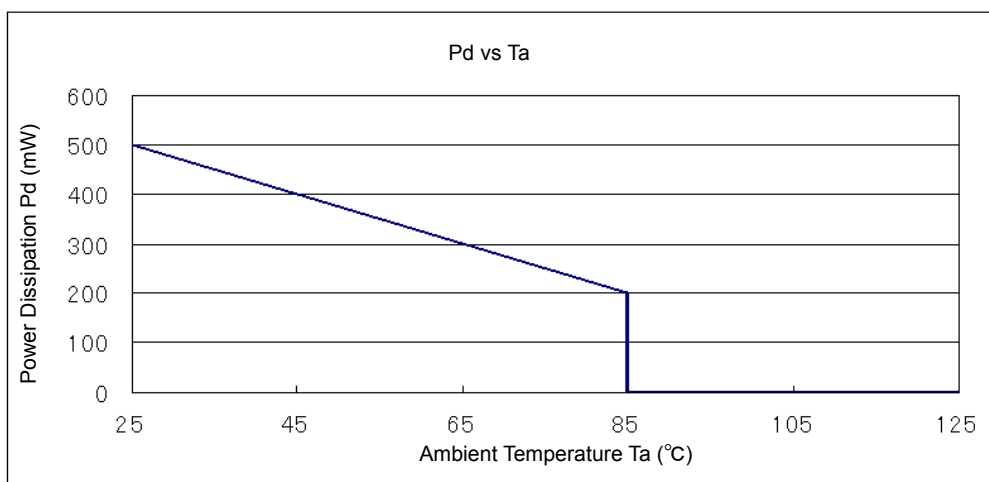


Evaluation Board (Unit: mm)

2. Power Dissipation vs. Ambient Temperature

Board Mount ($T_j \text{ max} = 125^\circ\text{C}$)

Ambient Temperature ($^\circ\text{C}$)	Power Dissipation P_d (mW)	Thermal Resistance ($^\circ\text{C/W}$)
25	500	200.00
85	200	

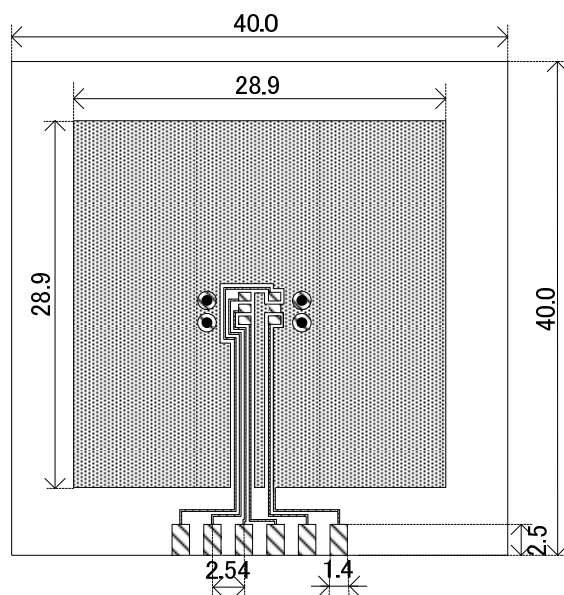


● SOT-25 Power Dissipation

Power dissipation data for the SOT-25 is shown in this page.
The value of power dissipation varies with the mount board conditions.
Please use this data as one of reference data taken in the described condition.

1. Measurement Condition (Reference data)

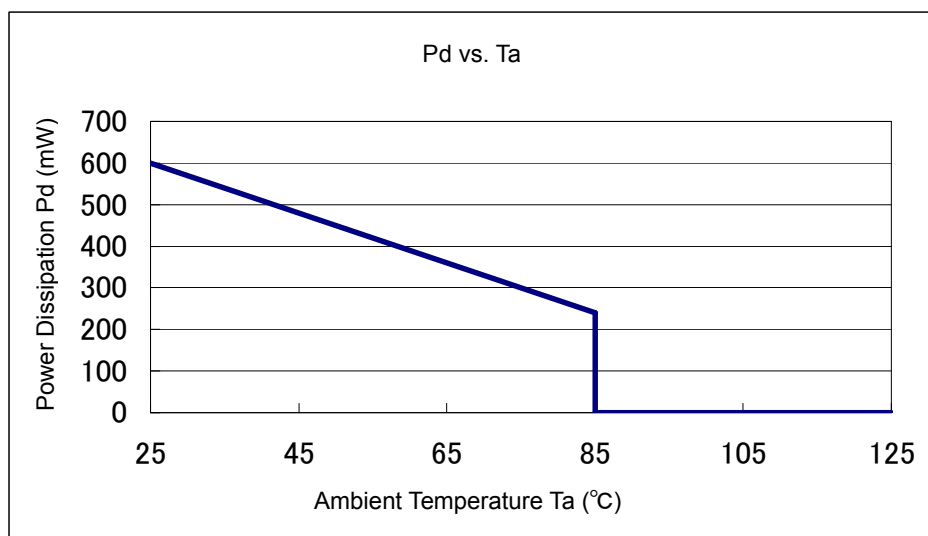
Condition: Mount on a board
Ambient: Natural convection
Soldering: Lead (Pb) free
Board: Dimensions 40 x 40 mm (1600 mm² in one side)
Copper (Cu) traces occupy 50% of the board area
In top and back faces
Package heat-sink is tied to the copper traces
(Board of SOT-26 is used.)
Material: Glass Epoxy (FR-4)
Thickness: 1.6 mm
Through-hole: 4 x 0.8 Diameter



2. Power Dissipation vs. Ambient Temperature

Board Mount ($T_j \text{ max} = 125^\circ\text{C}$)

Ambient Temperature ($^\circ\text{C}$)	Power Dissipation P_d (mW)	Thermal Resistance ($^\circ\text{C/W}$)
25	600	166.67
85	240	



● USP-3 Power Dissipation

Power dissipation data for the USP-3 is shown in this page.

The value of power dissipation varies with the mount board conditions.

Please use this data as one of reference data taken in the described condition.

1. Measurement Condition (Reference data)

Condition: Mount on a board

Ambient: Natural convection

Soldering: Lead (Pb) free

Board: Dimensions 40 x 40 mm
(1600 mm² in one side)
Copper (Cu) traces occupy 50% of the
board area

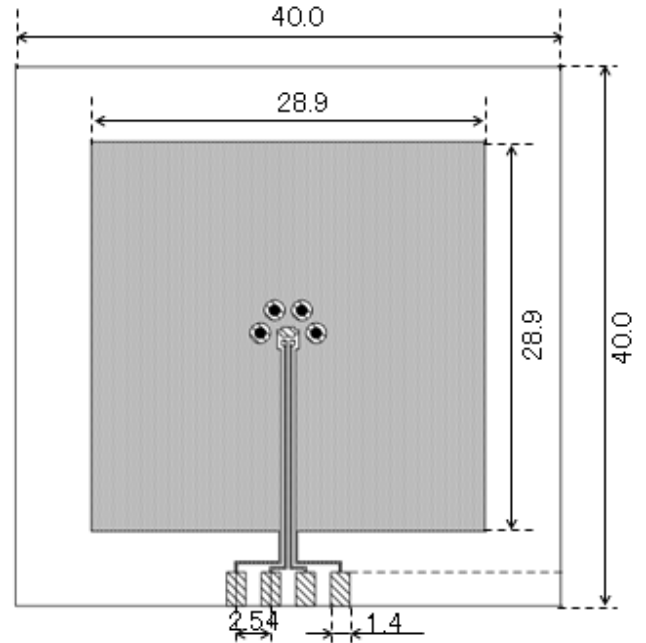
In top and back faces

Package heat-sink is tied to the copper
traces

Material: Glass Epoxy (FR-4)

Thickness: 1.6 mm

Through-hole: 4 x 0.8 Diameter

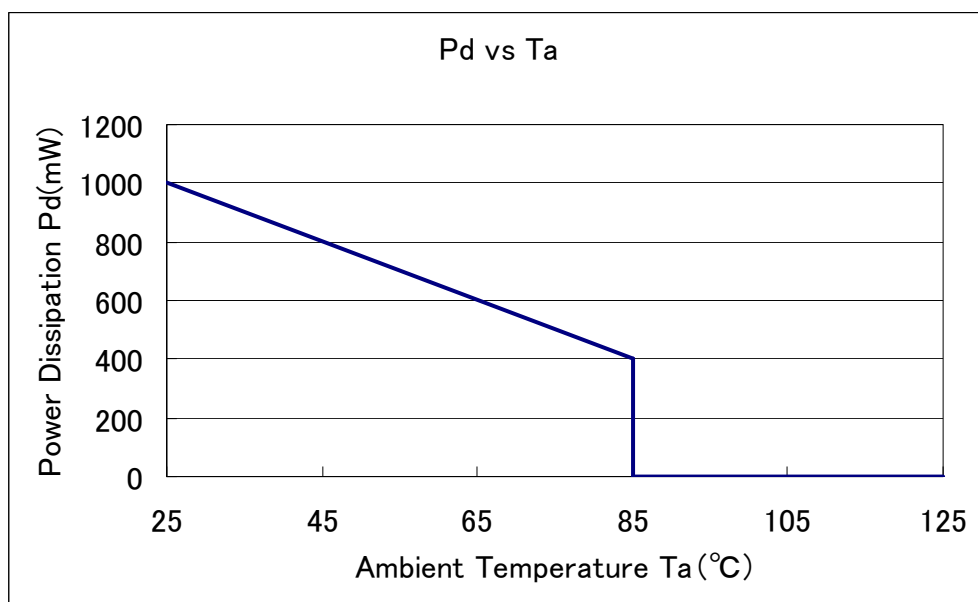


Evaluation Board (Unit: mm)

2. Power Dissipation vs. Ambient Temperature

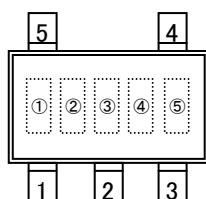
Board Mount (T_j max = 125°C)

Ambient Temperature (°C)	Power Dissipation Pd (mW)	Thermal Resistance (°C/W)
25	1000	100.00
85	400	

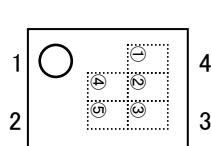


■ MARKING RULE

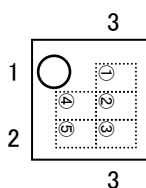
SOT-25



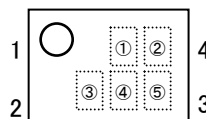
USP-4



USP-3



USPN-4



■ SOT-25/USP-4/USP-3/USPN-4

① represents product series

MARK	PRODUCT SERIES
A	XC6501*****

② represents type of regulator

MARK				PRODUCT SERIES
OUTPUT VOLTAGE 0.1V INCREMENTS		OUTPUT VOLTAGE 0.05V INCREMENTS		
VOLTAGE= 1.2~3.0V	VOLTAGE= 3.1~5.0V	VOLTAGE= 1.25~3.05V	VOLTAGE= 3.15~4.95V	
U	A	E	M	
V	B	F	N	XC6501A*****
X	C	H	R	XC6501B*****
Y	D	K	S	XC6501C*****
Z	P	L	T	XC6501D*****
				XC6501P*****

③ represents type of output voltage range

MARK	OUTPUT VOLTAGE (V)				MARK	OUTPUT VOLTAGE (V)			
0	-	3.10	-	3.15	F	1.60	4.60	1.65	4.65
1	-	3.20	-	3.25	H	1.70	4.70	1.75	4.75
2	-	3.30	-	3.35	K	1.80	4.80	1.85	4.85
3	-	3.40	-	3.45	L	1.90	4.90	1.95	4.95
4	-	3.50	-	3.55	M	2.00	5.00	2.05	-
5	-	3.60	-	3.65	N	2.10	-	2.15	-
6	-	3.70	-	3.75	P	2.20	-	2.25	-
7	-	3.80	-	3.85	R	2.30	-	2.35	-
8	-	3.90	-	3.95	S	2.40	-	2.45	-
9	-	4.00	-	4.05	T	2.50	-	2.55	-
A	-	4.10	-	4.15	U	2.60	-	2.65	-
B	1.20	4.20	1.25	4.25	V	2.70	-	2.75	-
C	1.30	4.30	1.35	4.35	X	2.80	-	2.85	-
D	1.40	4.40	1.45	4.45	Y	2.90	-	2.95	-
E	1.50	4.50	1.55	4.55	Z	3.00	-	3.05	-

④,⑤ represents production lot number

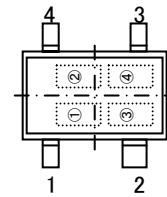
01 to 09, 0A to 0Z, 11 to 9Z, A1 to A9, AA to Z9, ZA to ZZ repeated.

G, I, J, O, Q, W excepted.

*No character inversion used.

MARKING RULE (Continued)

SSOT-24



SSOT-24

① represents type of regulator

MARK				PRODUCT SERIES
VOLTAGE= 1.2~2.15V	VOLTAGE= 2.2~3.15V	VOLTAGE= 3.2~4.15V	VOLTAGE= 4.2~5.0V	
5	6	7	8	XC6501A****
D	E	F	H	XC6501B****
R	S	T	0	XC6501C****
V	X	Y	Z	XC6501D****

② represents type of output voltage range

MARK	OUTPUT VOLTAGE (V)				MARK	OUTPUT VOLTAGE (V)			
A	1.20	2.20	3.20	4.20	N	1.70	2.70	3.70	4.70
B	1.25	2.25	3.25	4.25	P	1.75	2.75	3.75	4.75
C	1.30	2.30	3.30	4.30	R	1.80	2.80	3.80	4.80
D	1.35	2.35	3.35	4.35	S	1.85	2.85	3.85	4.85
E	1.40	2.40	3.40	4.40	T	1.90	2.90	3.90	4.90
F	1.45	2.45	3.45	4.45	U	1.95	2.95	3.95	4.95
H	1.50	2.50	3.50	4.50	V	2.00	3.00	4.00	5.00
K	1.55	2.55	3.55	4.55	X	2.05	3.05	4.05	-
L	1.60	2.60	3.60	4.60	Y	2.10	3.10	4.10	-
M	1.65	2.65	3.65	4.65	Z	2.15	3.15	4.15	-

③,④ represents production lot number

01 to 09, 0A to 0Z, 11 to 9Z, A1 to A9, AA to Z9, ZA to ZZ repeated.

G, I, J, O, Q, W excepted.

*No character inversion used.

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